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112930 U.S. PTO
11/034400



011105

To the Honorable Assistant Commissioner for Patents: Please record the attached
Original documents or copy thereof.

1. Name of conveying party(ies) with the
execution date:

YI-WEI CHEN, November 01, 2004
TZUNG-YU HUNG, November 01, 2004
YI-YIING CHIANG, November 01, 2004
CHAO-CHING HSIEH, November 01, 2004
YU-LAN CHANG, November 01, 2004

2. Name/address of receiving Party(ies)

UNITED MICROELECTRONICS CORP.

NO. 3, LI-HSIN RD. II, SCIENCE-BASED
INDUSTRIAL PARK, HSINCHU, TAIWAN,
R.O.C.

3. Nature of conveyance:

- Assignment Security Agreement
- Merger Change of Name
- Reassignment Other

Add'l names of receiving parties
Attached? Yes No

4. Application number(s) or patent number(s):

If this document is being file together with a new application, the execution date of
the application is November 01, 2004.

A. Patent Application No. (s)

B. Patent No.(s)

1
Additional number attached?

Yes No

5. Name and address of party to whom
correspondence concerning document
should be mailed:

J. C. Patents
4 Venture, Suite 250
Irvine, CA 92618
(949) 660-0761

6. Total No. of applications and patents
involved:

ONE (1)

7. Total fee(37CFR§3.41): \$40.00

- Enclosed
- Charge to Acct. No. 50-0710
(Order No. JCLA14506)

8. Total number of pages, including
Cover sheet, attachments and Document 3.


Atty Docket No.: JCLA14506

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9. Statement and Signature:

To the best of my knowledge and belief, the forging information is true and
Correct and any attached copy is a true copy of the original document.

Jiawei Huang
Name of person
Signing Registration
No. 43,330


Signature

11/11/2005
Date

01/25/2005 EDOOPER 00000269 11034400
40.00 DP
01 FC:8021

ASSIGNMENT

WHEREAS,

- | | |
|--------------------|---------------------|
| 1. Yi-Wei Chen | 2. Tzung-Yu Hung |
| 3. Yi-Yiing Chiang | 4. Chao-Ching Hsieh |
| 5. Yu-Lan Chang | |

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **METHOD OF FABRICATING METAL SILICIDE LAYER**

Filed: Serial No.

Executed concurrently with the execution of this instrument

WHEREAS, United Microelectronics Corp.
of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Yi-Wei Chen

Signature:

Sole or First Joint Inventor: Yi-Wei Chen

November 1, 2004

Date:

Tzung-Yu Hung

Signature:

Second Joint Inventor (if any): Tzung-Yu Hung

November 1, 2004

Date:

Yi-Yiing Chiang

Signature:

Third Joint Inventor (if any): Yi-Yiing Chiang

November 1, 2004

Date:

Chao-Ching Hsieh

Signature:

Fourth Joint Inventor (if any): Chao-Ching Hsieh

November 1, 2004

Date:

Yu-Lan Chang

Signature:

Fifth Joint Inventor (if any): Yu-Lan Chang

November 1, 2004

Date: